BCD to 7-segment latch/decoder/driver Rev. 7 — 11 November 2011

Product data sheet

1. **General description**

The HEF4511B is a BCD to 7-segment latch/decoder/driver with four address inputs (D0 to D3), an active HIGH latch enable input (LE), an active LOW ripple blanking input (BL), an active LOW lamp test input (LT), and seven active HIGH NPN bipolar transistor segment outputs (Qa to Qg).

When LE is LOW and \overline{BL} is HIGH, the state of the segment outputs (Qa to Qg) is determined by the data on D0 to D3. When LE goes HIGH, the last data present on D0 to D3 is stored in the latches and the segment outputs remain unchanged. When \overline{LT} is LOW, all of the segment outputs are HIGH independent of all other input conditions. With LT HIGH, a LOW on BL forces all segment outputs LOW. The inputs LT and BL do not affect the latch circuit.

It operates over a recommended V_{DD} power supply range of 3 V to 15 V referenced to V_{SS} (usually ground). Unused inputs must be connected to V_{DD}, V_{SS}, or another input.

Features and benefits 2.

- Fully static operation
- 5 V, 10 V, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from -40 °C to +85 °C and -40 °C to +125 °C
- Complies with JEDEC standard JESD 13-B

3. Ordering information

Table 1. **Ordering information**

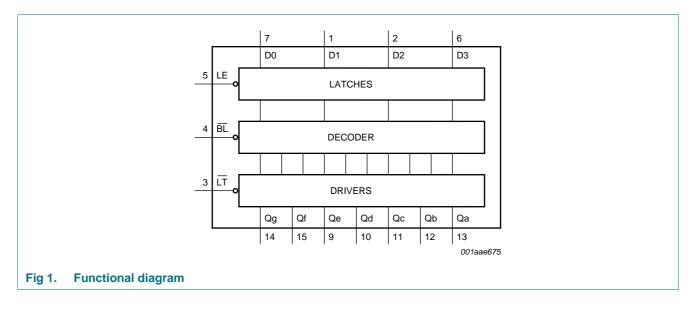
All types operate from −40 °C to +125 °C.

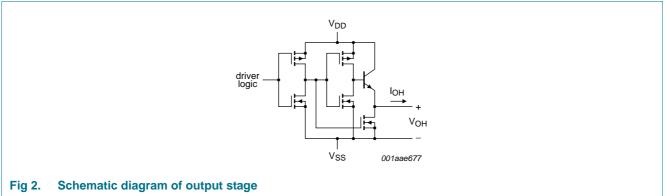
Type number	Package	Package							
	Name	Description	Version						
HEF4511BP	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4						
HEF4511BT	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						



BCD to 7-segment latch/decoder/driver

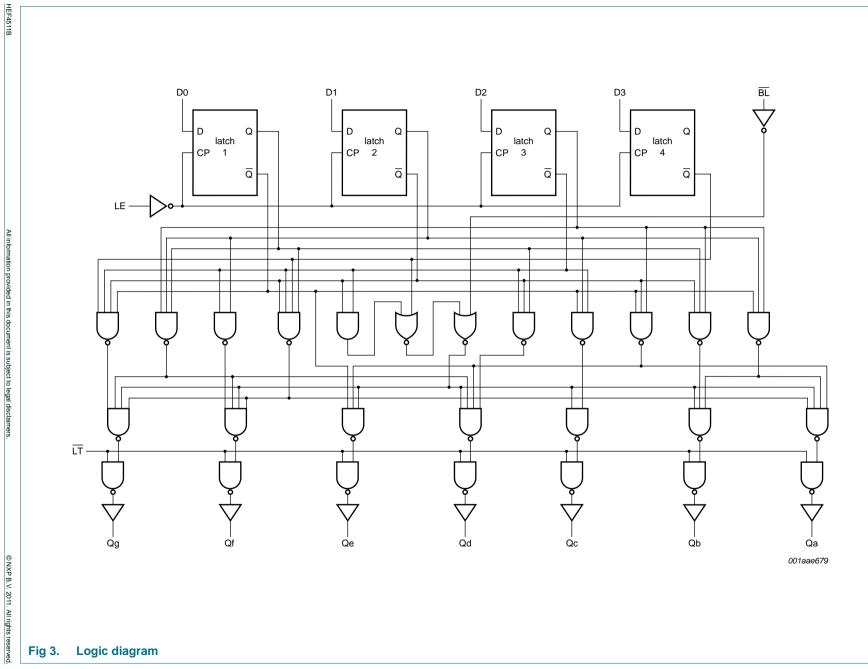
4. Functional diagram





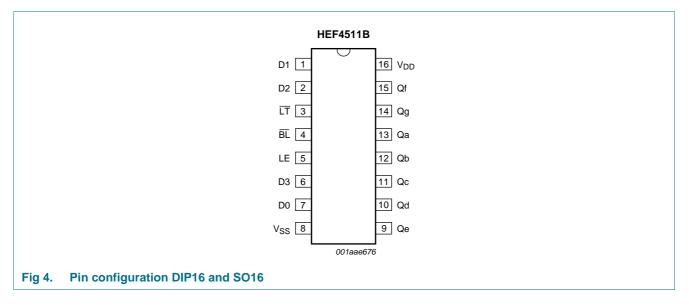
HEF4511B





5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
LT	3	lamp test input (active LOW)
BL	4	ripple blanking input (active LOW)
LE	5	latch enable input (active HIGH)
D0 to D3	7, 1, 2, 6	address (data) input
V _{SS}	8	ground supply voltage
Qa to Qg	13, 12, 11, 10, 9, 15, 14	segment output
V _{DD}	16	supply voltage

6. Functional description

Table	3.	Function	table ^[1]
I GOIO	•••	i unotion	

Input	s						Outpu	uts						Display
LE	BL	LT	D3	D2	D1	D0	Qa	Qb	Qc	Qd	Qe	Qf	Qg	
Х	Х	L	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	8
Х	L	Н	Х	Х	Х	Х	L	L	L	L	L	L	L	blank
L	Н	Н	L	L	L	L	Н	Н	Н	Н	Н	Н	L	0
L	Н	Н	L	L	L	Н	L	Н	Н	L	L	L	L	1
L	Н	Н	L	L	Н	L	Н	Н	L	Н	Н	L	Н	2
L	Н	Н	L	L	Н	Н	Н	Н	Н	Н	L	L	Н	3
L	Н	Н	L	Н	L	L	L	Н	Н	L	L	Н	Н	4
L	Н	Н	L	Н	L	Н	Н	L	Н	Н	L	Н	Н	5
L	Н	Н	L	Н	Н	L	L	L	Н	Н	Н	Н	Н	6
L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	L	L	L	7
L	Н	Н	Н	L	L	L	Н	Н	Н	Н	Н	Н	Н	8
L	Н	Н	Н	L	L	Н	Н	Н	Н	L	L	Н	Н	9
L	Н	Н	Н	L	Н	Х	L	L	L	L	L	L	L	blank
L	Н	Н	Н	Н	Х	Х	L	L	L	L	L	L	L	blank
Н	Н	Н	Х	Х	Х	Х	N.C.	N.C.	N.C.	N.C.	N.C.	N.C.	N.C.	N.C.

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; N.C. = no change.

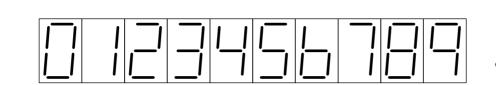




Fig 5. Seven segment digital display with segment designation

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Parameter	Conditions	Min	Max	Unit
supply voltage		-0.5	+18	V
input clamping current	$V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm DD}$ + 0.5 V	-	±10	mA
input voltage		-0.5	V _{DD} + 0.5	V
output clamping current	V_{O} < –0.5 V or V_{O} > V_{DD} + 0.5 V	-	±10	mA
input/output current		-	±10	mA
HIGH-level output current		<u>[1]</u> –25	-	mA
supply current		-	50	mA
storage temperature		-65	+150	°C
ambient temperature		-40	+125	°C
total power dissipation	T _{amb} = 125 °C			
	DIP16 package	[2] _	750	mW
	SO16 package	<u>[3]</u> _	500	mW
power dissipation	per output	-	100	mW
	supply voltage input clamping current input voltage output clamping current input/output current HIGH-level output current supply current storage temperature ambient temperature total power dissipation	supply voltageinput clamping current $V_1 < -0.5 V \text{ or } V_1 > V_{DD} + 0.5 V$ input voltage $V_0 < -0.5 V \text{ or } V_0 > V_{DD} + 0.5 V$ output clamping current $V_0 < -0.5 V \text{ or } V_0 > V_{DD} + 0.5 V$ input/output currentHIGH-level output currentsupply currentsupply currentstorage temperatureambient temperaturetotal power dissipation $T_{amb} = 125 \text{ °C}$ DIP16 packageSO16 package	supply voltage-0.5input clamping current $V_1 < -0.5 V \text{ or } V_1 > V_{DD} + 0.5 V$ -input voltage-0.5-0.5output clamping current $V_0 < -0.5 V \text{ or } V_0 > V_{DD} + 0.5 V$ -input/output current11-25supply currentHIGH-level output current11-25supply currentstorage temperature-65ambient temperature-40total power dissipationTamb = 125 °CDIP16 package2SO16 package3	supply voltage -0.5 $+18$ input clamping current $V_1 < -0.5 V \text{ or } V_1 > V_{DD} + 0.5 V$ $ \pm 10$ input voltage $-0.5 V \text{ or } V_0 > V_{DD} + 0.5 V$ $ \pm 10$ output clamping current $V_0 < -0.5 V \text{ or } V_0 > V_{DD} + 0.5 V$ $ \pm 10$ input/output current $V_0 < -0.5 V \text{ or } V_0 > V_{DD} + 0.5 V$ $ \pm 10$ HIGH-level output current11 -25 $-$ supply current11 -25 $-$ supply current -65 $+150$ ambient temperature -40 $+125$ total power dissipation $T_{amb} = 125 \text{ °C}$ -40 $T_{amb} = 125 \text{ °C}$ -750 500 SO16 package 3 $ 500$

[1] A destructive high current mode may occur if V₁ and V₀ are not constrained to the range $V_{SS} \le V_1$ or $V_0 \le V_{DD}$.

[2] For DIP16 package: Ptot derates linearly with 12 mW/K above 70 °C.

[3] For SO16 package: P_{tot} derates linearly with 8 mW/K above 70 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DD}	supply voltage		3	-	15	V
VI	input voltage		0	-	V_{DD}	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{DD} = 5 V$	-	-	3.75	μs/V
		V _{DD} = 10 V	-	-	0.5	μs/V
		V _{DD} = 15 V	-	-	0.08	μs/V

9. Static characteristics

Table 6. Static characteristics

 $V_{SS} = 0$ V; $V_l = V_{SS}$ or V_{DD} ; unless otherwise specified.

Symbol	Parameter	Conditions	V_{DD}	T _{amb} =	−40 °C	T _{amb} =	+25 °C	T _{amb} =	+85 °C	T _{amb} = -	⊦125 °C	Unit
				Min	Max	Min	Max	Min	Мах	Min	Max	
V _{IH}	HIGH-level	I _O < 1 μA	5 V	3.5	-	3.5	-	3.5	-	3.5	-	V
	input voltage		10 V	7.0	-	7.0	-	7.0	-	7.0	-	V
			15 V	11.0	-	11.0	-	11.0	-	11.0	-	V
V _{IL}	LOW-level	$ I_0 < 1 \ \mu A$	5 V	-	1.5	-	1.5	-	1.5	-	1.5	V
	input voltage		10 V	-	3.0	-	3.0	-	3.0	-	3.0	V
			15 V	-	4.0	-	4.0	-	4.0	-	4.0	V
V _{OH}	HIGH-level output voltage	see <u>Table 7</u>	-	-	-	-	-	-	-	-	-	-
V _{OL} LOW-level output voltage	$ I_0 < 1 \ \mu A$	5 V	-	0.05	-	0.05	-	0.05	-	0.05	V	
		10 V	-	0.05	-	0.05	-	0.05	-	0.05	V	
		15 V	-	0.05	-	0.05	-	0.05	-	0.05	V	
I _{OH}	OH HIGH-level	V _O = 2.5 V	5 V	-	-1.7	-	-1.4	-	-1.1	-	-1.1	mA
	output current	V _O = 4.6 V	5 V	-	-0.64	-	-0.5	-	-0.36	-	-0.36	mA
		$V_{O} = 9.5 V$	10 V	-	-1.6	-	-1.3	-	-0.9	-	-0.9	mA
		V _O = 13.5 V	15 V	-	-4.2	-	-3.4	-	-2.4	-	-2.4	mA
I _{OL}	LOW-level	$V_{O} = 0.4 V$	5 V	0.64	-	0.5	-	0.36	-	0.36	-	mA
	output current	$V_{O} = 0.5 V$	10 V	1.6	-	1.3	-	0.9	-	0.9	-	mA
		V _O = 1.5 V	15 V	4.2	-	3.4	-	2.4	-	2.4	-	mA
I _I	input leakage current		15 V	-	±0.1	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{DD}	supply current	I _O = 0 A	5 V	-	5	-	5	-	150	-	150	μΑ
			10 V	-	10	-	10	-	300	-	300	μA
			15 V	-	20	-	20	-	600	-	600	μΑ
CI	input capacitance		-	-	-	-	7.5	-	-	-	-	pF

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Symbol	Parameter	I _{OH}	V _{DD}	T _{amb} = -40 °C	T _{amb} =	+25 °C	T _{amb} = +85 °C	T _{amb} = +125 °C	Unit
		mA	V	Min	Min	Тур	Min	Min	
V _{ОН}	HIGH-level	0	5 V	4.10	4.10	4.40	4.10	4.10	V
	output voltage		10 V	9.10	9.10	9.90	9.10	9.10	V
			15 V	14.10	14.10	14.40	14.10	14.10	V
		5	5 V	-	-	4.30	-	-	V
			10 V	-	-	9.30	-	-	V
			15 V	-	-	14.30	-	-	V
		10	5 V	3.60	3.60	4.25	3.30	3.20	V
			10 V	8.75	8.75	9.25	8.45	8.35	V
			15 V	13.75	13.75	14.30	13.45	13.35	V
		15	5 V	-	-	4.20	-	-	V
			10 V	-	-	9.20	-	-	V
			15 V	-	-	14.20	-	-	V
		20	5 V	2.80	2.80	4.20	2.50	2.30	V
			10 V	8.10	8.10	9.20	7.80	7.60	V
			15 V	13.10	13.10	14.20	12.80	12.60	V
		25	5 V	-	-	4.15	-	-	V
			10 V	-	-	9.20	-	-	V
			15 V	-	-	14.20	-	-	V

Table 7. Static characteristics for V_{OH}

10. Dynamic characteristics

Table 8. Dynamic characteristics

$V_{SS} = 0$ V; $T_{amb} = 25$ °C; for test circuit see <u>Figure 8</u>.

Symbol	Parameter	Conditions	V _{DD}	Extrapolation formula ^[1]	Min	Тур	Max	Unit
t _{PHL}	HIGH to LOW	$Dn \rightarrow Qn;$	5 V	128 ns + (0.55 ns/pF)C _L	-	155	310	ns
	propagation delay	see <u>Figure 6</u>	10 V	49 ns + (0.23 ns/pF)C _L	-	60	120	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		$LE \rightarrow Qn;$	5 V	133 ns + (0.55 ns/pF)C _L	-	160	320	ns
		see Figure 6	10 V	49 ns + (0.23 ns/pF)C _L	-	60	120	ns
			15 V	37 ns + (0.16 ns/pF)C _L	-	45	90	ns
		$\overline{BL} \to Qn;$	5 V	93 ns + (0.55 ns/pF)C _L	-	120	240	ns
		see <u>Figure 6</u>	10 V	39 ns + (0.23 ns/pF)C _L	-	50	100	ns
			15 V	27 ns + (0.16 ns/pF)C _L	-	35	70	ns
		$\overline{\text{LT}} \rightarrow \text{Qn};$	5 V	52 ns + (0.55 ns/pF)C _L	-	80	160	ns
		see <u>Figure 6</u>	10 V	19 ns + (0.23 ns/pF)C _L	-	30	60	ns
			15 V	12 ns + (0.16 ns/pF)C _L	-	20	40	ns

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BCD to 7-segment latch/decoder/driver

Symbol	Parameter	Conditions	V _{DD}	Extrapolation formula ^[1]	Min	Тур	Max	Unit
t _{PLH}	LOW to HIGH	$Dn \rightarrow Qn;$	5 V	108 ns + (0.55 ns/pF)C _L	-	135	270	ns
	propagation delay	see Figure 6	10 V	44 ns + (0.23 ns/pF)C _L	-	55	110	ns
			15 V	32 ns + (0.16 ns/pF)C _L	-	40	80	ns
		$LE \rightarrow Qn;$	5 V	133 ns + (0.55 ns/pF)C _L	-	160	320	ns
		see Figure 6	10 V	59 ns + (0.23 ns/pF)C _L	-	70	140	ns
			15 V	42 ns + (0.16 ns/pF)C _L	-	50	100	ns
		$\overline{\text{BL}} \rightarrow \text{Qn};$	5 V	78 ns + (0.55 ns/pF)C _L	-	105	210	ns
		see Figure 6	10 V	29 ns + (0.23 ns/pF)C _L	-	40	80	ns
			15 V	22 ns + (0.16 ns/pF)C _L	-	30	60	ns
		$\overline{\text{LT}} \rightarrow \text{Qn};$	5 V	33 ns + (0.55 ns/pF)C _L	-	60	120	ns
		see Figure 6	10 V	19 ns + (0.23 ns/pF)C _L	-	30	60	ns
			15 V	17 ns + (0.16 ns/pF)C _L	-	25	50	ns
t _{THL}	HIGH to LOW output transition time	see Figure 6	5 V	10 ns + (1.00 ns/pF)C _L	-	60	120	ns
			10 V	9 ns + (0.42 ns/pF)C _L	-	30	60	ns
			15 V	6 ns + (0.28 ns/pF)C _L	-	20	40	ns
t _{TLH}	LOW to HIGH output	see Figure 6	5 V	20 ns + (1.00 ns/pF)C _L	-	25	50	ns
	transition time		10 V	13 ns + (0.06 ns/pF)C _L	-	16	32	ns
			15 V	10 ns + (0.06 ns/pF)C _L	-	13	26	ns
t _{su}	set-up time	$Dn \rightarrow LE;$	5 V		50	25	-	ns
		see Figure 7	10 V		25	12	-	ns
			15 V		20	9	-	ns
t _h	hold time	$Dn\toLE;$	5 V		60	30	-	ns
		see Figure 7	10 V		30	15	-	ns
			15 V		25	12	-	ns
tw	pulse width	LE input LOW;	5 V		80	40	-	ns
		minimum width;	10 V		40	20	-	ns
		see <u>Figure 7</u>	15 V		35	17	-	ns

Table 8. Dynamic characteristics ... continued

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown (C_L in pF).

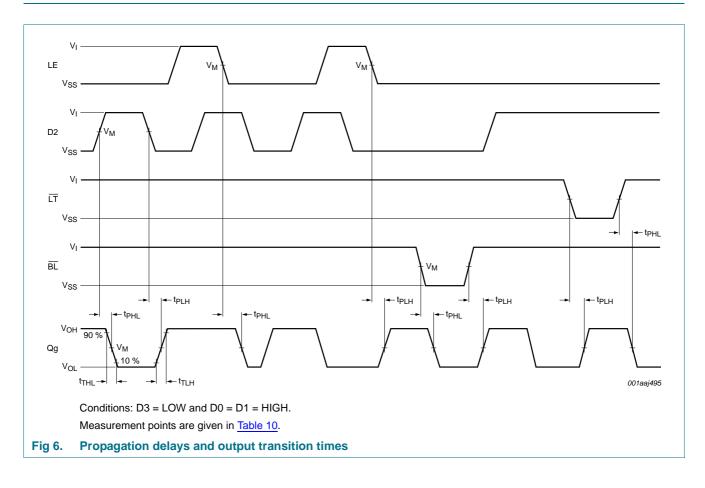
Table 9. Dynamic power dissipation P_D

 P_D can be calculated from the formulas shown. $V_{SS} = 0$ V; $t_r = t_f \le 20$ ns; $T_{amb} = 25$ °C.

Symbol	Parameter	V _{DD}	Typical formula for P_D (μ W)	where:
PD	dynamic power	5 V	$P_{D} = 1000 \times f_{i} + \Sigma (f_{o} \times C_{L}) \times V_{DD}^{2}$	$f_i = input frequency in MHz;$
	dissipation	10 V	$P_D = 4000 \times f_i + \Sigma (f_o \times C_L) \times V_DD^2$	$f_o = output frequency in MHz;$
		15 V	$P_{D} = 10000 \times f_{i} + \Sigma(f_{o} \times C_{L}) \times V_{DD}^{2}$	C_L = output load capacitance in pF;
				V _{DD} = supply voltage in V;
				$\Sigma(f_o \times C_L)$ = sum of the outputs.

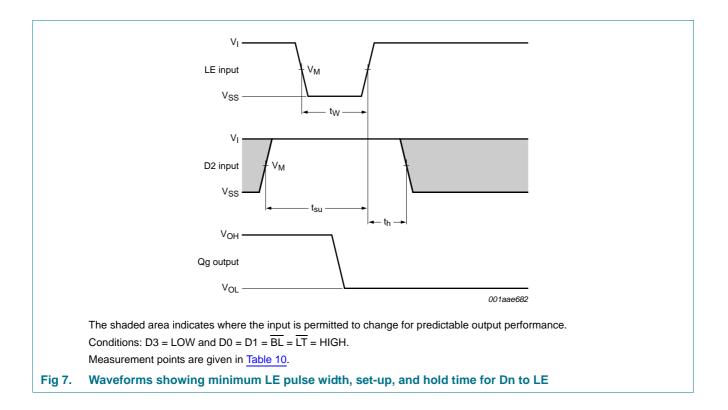
BCD to 7-segment latch/decoder/driver

11. Waveforms



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BCD to 7-segment latch/decoder/driver



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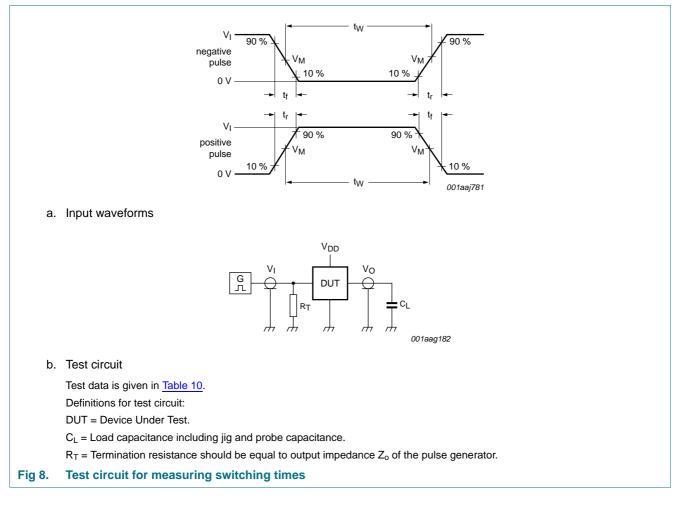


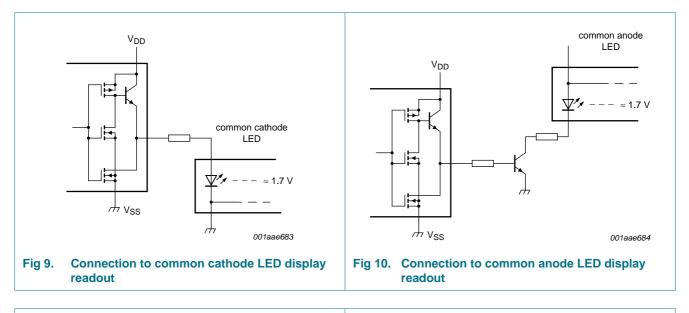
Table 10. Measurement points and test data

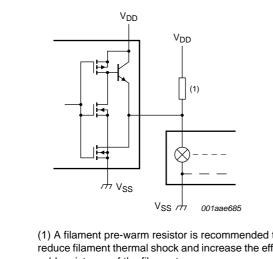
Supply voltage	Input	Load		
	VI	V _M	t _r , t _f	CL
5 V to 15 V	V _{DD}	0.5V _I	≤ 20 ns	50 pF

BCD to 7-segment latch/decoder/driver

12. Application information

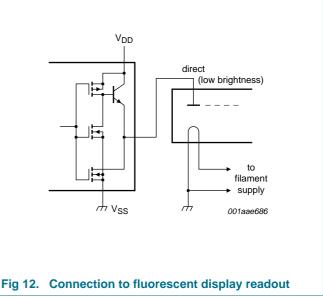
- Driving LED displays
- Driving incandescent displays •
- Driving fluorescent displays •
- Driving LCD displays ٠
- Driving gas discharge displays





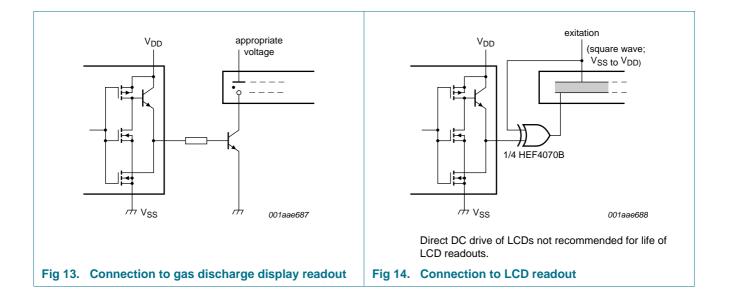
(1) A filament pre-warm resistor is recommended to reduce filament thermal shock and increase the effective cold resistance of the filament.





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BCD to 7-segment latch/decoder/driver



BCD to 7-segment latch/decoder/driver

13. Package outline

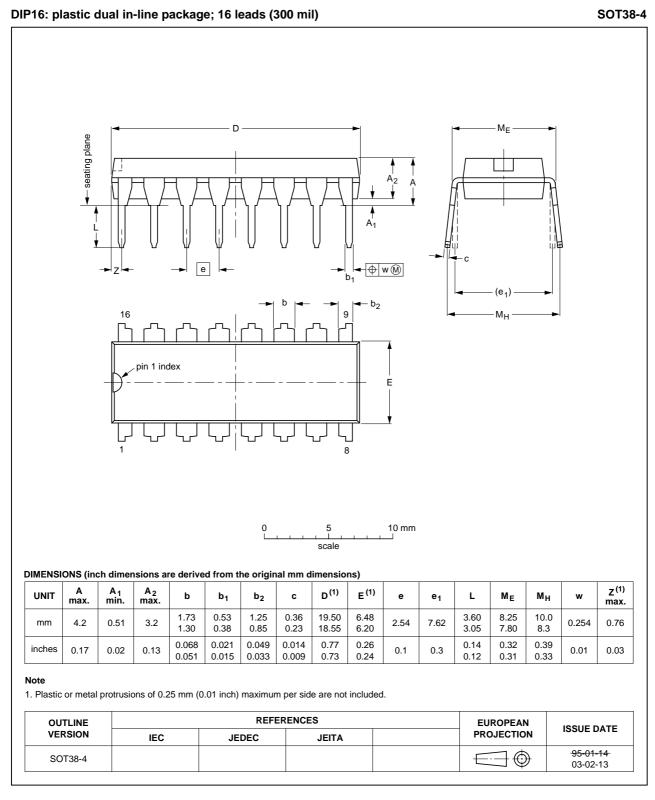


Fig 15. Package outline SOT38-4 (DIP16)

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HEF4511B

BCD to 7-segment latch/decoder/driver

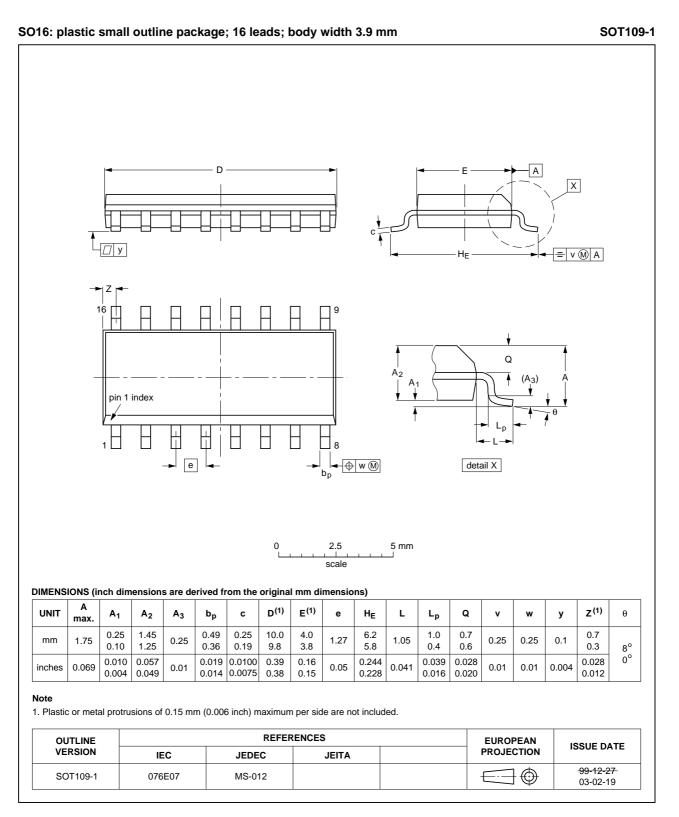


Fig 16. Package outline SOT109-1 (SO16)

HEF4511B

14. Revision history

Table 11. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
HEF4511B v.7	20111111	Product data sheet	-	HEF4511B v.6	
Modifications:	Section Applications removed				
	• <u>Table 6</u> : I _{OH}	minimum values changed to	o maximum		
HEF4511B v.6	20091207	Product data sheet	-	HEF4511B v.5	
HEF4511B v.5	20090813	Product data sheet	-	HEF4511B v.4	
HEF4511B v.4	20090305	Product data sheet	-	HEF4511B_CNV v.3	
HEF4511B_CNV v.3	19950101	Product specification	-	HEF4511B_CNV v.2	
HEF4511B_CNV v.2	19950101	Product specification	-	-	

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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Date of release: 11 November 2011 Document identifier: HEF4511B

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